

Soldering tip bevelled 45° 0.7mm (0.028"), Micro Fine - Thermaltronics S60BV007

Item no. WL38179

Manufacturer Thermaltronics

Soldering tip bevelled 45° 0.7mm (0.028"), Micro Fine from the Thermaltronics S series, lead-free and RoHS compliant. Temperature range 325 - 358 °C, tip width 0,7 mm. Fits handpiece SHP-SM.

TECHNICAL DATA

Ausführungsklasse **ESD (antistatic)**

Country of Manufacture **United States**

HS-Code **85159080900**

Weight **0.1 kg**



STANDARDS & COMPLIANCE

ESD safe

DESCRIPTION

Soldering tip bevelled 45° 0.7mm (0.028"), Micro Fine from the Thermaltronics S series for precise lead-free soldering. The tip operates in the 325 - 358 °C temperature range and is 0,7 mm wide, for repeatable joints on fine electronics.

KEY BENEFITS

- Tip width 0,7 mm (0,03 in) for matched heat transfer
- 325 - 358 °C temperature range of the S series
- RoHS compliant and lead-free
- Fits handpiece SHP-SM

TECHNICAL DATA

Item no.	WL38179
Manufacturer no.	S60BV007
Soldering tip series	S
Temperature range	325 - 358 °C

Tip shape	micro fine
Tip width	0,7 mm (0,03 in)
Tip length	13 mm
Suitable handpiece	SHP-SM
Suitable control unit	TMT-2000PS, SP200, MFR-PS1100, MFR-PS2200
Alignment	bevelled

APPLICATIONS

Suitable for SMD and THT soldering on printed circuit boards in repair, production and laboratory work.

COMPATIBILITY AND SCOPE OF DELIVERY

For use with handpiece SHP-SM and control unit TMT-2000PS, SP200, MFR-PS1100, MFR-PS2200. Supplied as a single piece.

RoHS compliant, lead-free, ESD-safe. Manufactured by Thermaltronics, USA.